DATASHEET - BP-F-400/17/3-F-W



White floor standing distribution board, flexible surface mounting, W = 400 mm, H = 1760 mm, D = 300 mm

Powering Business Worldwide*

Part no. BP-F-400/17/3-F-W

Catalog No. 102407

EL-Nummer (Norway)

2459219

Delivery program

Mounting type		Floor standing distribution board
Material		Sheet steel
Installation site		Indoor
Degree of Protection		IP30
Surface finish		With powder coating
Width	mm	400
Depth	mm	300
Height	mm	1760
Colour		white (RAL 9016)

Design verification as per IEC/EN 61439

chnical data for design verification			
Heat dissipation, at an ambient temperature of 35°C, delta T: 20 degrees in top of the enclosure, calculated as per IEC 60890 $$			
Individual enclosure, free-standing	P_{V}	W	101
Starting enclosure, free-standing	P_{V}	W	88
Middle enclosure, free-standing	P_{V}	W	75
Individual enclosure for wall mounting	P_{V}	W	84
Starting enclosure for wall mounting	P_{V}	W	73
Middle enclosure for wall mounting	P_{V}	W	65
Heat dissipation, at an ambient temperature of 35°C, delta T: 35 degrees in top of the enclosure, calculated as per IEC 60890			
Individual enclosure, free-standing	P_{V}	W	203
Starting enclosure, free-standing	P_{V}	W	176
Middle enclosure, free-standing	P_{V}	W	151
Individual enclosure for wall mounting	P_{V}	W	168
Starting enclosure for wall mounting	P_{V}	W	147
Middle enclosure for wall mounting	P_{V}	W	131
C/EN 61439 design verification			
10.2 Strength of materials and parts			
10.2.2 Corrosion resistance			Meets the product standard's requirements.
10.2.3.1 Verification of thermal stability of enclosures			Meets the product standard's requirements.
10.2.3.2 Verification of resistance of insulating materials to normal heat			Meets the product standard's requirements.
10.2.3.3 Verification of resistance of insulating materials to abnormal heat and fire due to internal electric effects $$			Meets the product standard's requirements.
10.2.4 Resistance to ultra-violet (UV) radiation			Not relevant to indoor installations.
10.2.5 Lifting			Met; assembled and secured as per the latest applicable instruction leaflet.
10.2.6 Mechanical impact			IK07

Meets the product standard's requirements. 10.3 Degree of protection of ASSEMBLIES 10.4 Clearances and creepage distances 10.5 Protection against electric shock 10.6 Incorporation of switching devices and components 10.7 Internal electrical circuits and connections 10.8 Connections for external conductors 10.9 Insulation properties 10.9.2 Power-frequency electric strength 10.9.3 Impulse withstand voltage 10.9.4 Testing of enclosures made of insulating material 10.10 Temperature rise 10.11 Short-circuit rating 10.12 Electromagnetic compatibility 10.13 Mechanical function Meets the product standard's requirements. Is the panel builder's responsibility. Is the panel builder's responsibility. U _i = 440 V AC 4 kV Does not apply to metal enclosures. The panel builder is responsibile for the temperature rise calculation. Eaton will provide heat dissipation data for the devices. 10.12 Electromagnetic compatibility Meets the product standard's requirements.		
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10.13 Mechanical function Meets the product standard's requirements.	10.12 Electromagnetic compatibility	Is the panel builder's responsibility.
	10.13 Mechanical function	Meets the product standard's requirements.

Technical data ETIM 7.0

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Cabinet enclosures (EG000011) / Enclosure/switchgear cabinet (empty) (EC000261)		
Electric engineering, automation, process control engineering / Electrical cabinet, housing, re	ack / Electrica	ıl cabinet (empty) / Electrical cabinet (ecl@ss10.0.1-27-18-01-01 [AGZ056016])
Width	mm	400
Height	mm	1760
Depth	mm	300
Material		Steel
Material quality		Other
Surface finishing		Powder coating
Colour		White
RAL-number		9016
With mounting plate		No
Mounting plate depth-adjustable		Yes
Number of locks		0
Floor installation possible		Yes
Wall fastening possible		No
Wall build in		No
Pole fastening		No
Tackable		Yes
Number of doors		0
Suitable for metrical mounting		Yes
Suitable for outdoor set-up		No
Pitched roof		No
EMC-version		Yes
Nith glazed door		No
With ventilation door		No
Nith backside door		No
Impact strength		IK08
Degree of protection (IP)		IP30
Degree of protection (NEMA)		